

# 1.2V Drive Pch MOSFET

# **RZE002P02**

#### ●Structure

Silicon P-channel MOSFET

#### ● Features

- 1) High speed switching.
- 2) Small package (EMT3).
- 3) 1.2V drive.

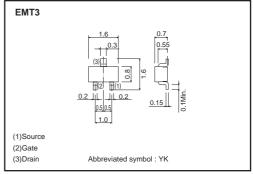
#### Applications

Switching

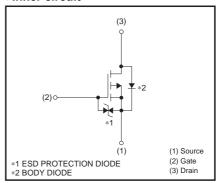
● Package specifications

	Package	Taping	
Type	Code	TL	
	Basic ordering unit (pieces)	3000	
RZE002P02		0	

#### ●Dimensions (Unit: mm)



#### ●Inner circuit



## ●Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		V <sub>DSS</sub>	-20	V
Gate-source voltage		V <sub>GSS</sub>	±10	V
Drain current	Continuous	I <sub>D</sub>	±200	mA
Drain current	Pulsed	I <sub>DP</sub> *1	±800	mA
Souce current	Continuous	Is	-100	mA
(Body diode)	Pulsed	I <sub>SP</sub> *1	-800	mA
Total power dissipation		P <sub>D</sub> *2	150	mW
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

#### Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a)*	833	°C/W

<sup>\*</sup> Each terminal mounted on a recommended land

<sup>\*1</sup> Pw≤10μs, Duty cycle≤1% \*2 Each terminal mounted on a recommended land

RZE002P02 Data Sheet

# ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	_	_	±10	μΑ	V <sub>GS</sub> = ±10V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	$V_{(BR)\;DSS}$	-20	_	_	V	I <sub>D</sub> = -1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	-	_	-1	μΑ	V <sub>DS</sub> = -20V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	-0.3	-	-1.0	V	V <sub>DS</sub> = -10V, I <sub>D</sub> = -100μA
		-	8.0	1.2	Ω	I <sub>D</sub> = -200mA, V <sub>G</sub> S= -4.5V
Otatia dasia assuma an atata		_	1.0	1.5	Ω	I <sub>D</sub> = -100mA, V <sub>G</sub> S= -2.5V
Static drain-source on-state resistance	R <sub>DS (on)</sub> *	-	1.3	2.2	Ω	I <sub>D</sub> = -100mA, V <sub>G</sub> s= -1.8V
resistance		_	1.6	3.5	Ω	I <sub>D</sub> = -40mA, V <sub>GS</sub> = -1.5V
		_	2.4	9.6	Ω	I <sub>D</sub> = -10mA, V <sub>GS</sub> = -1.2V
Forward transfer admittance	Y <sub>fs</sub> *	0.2	-	_	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -200mA
Input capacitance	Ciss	_	115	_	pF	V <sub>DS</sub> = -10V
Output capacitance	Coss	_	10	_	pF	V <sub>GS</sub> = 0V
Reverse transfer capacitance	Crss	-	6	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	_	6	_	ns	V <sub>DD</sub> ≒ −10V
Rise time	tr *	_	4	_	ns	ID= -100mA
Turn-off delay time	td (off) *	_	17	_	ns	V <sub>GS</sub> = −4.5V R <sub>L</sub> ≒100Ω
Fall time	t <sub>f</sub> *	_	17	_	ns	R <sub>G</sub> = 10Ω
Total gate charge	Qg *	1	1.4	_	nC	V <sub>DD</sub> ≒ −10V R <sub>L</sub> ≒50Ω
Gate-source charge	Qgs *	-	0.3	-	nC	I <sub>D</sub> = -200mA R <sub>G</sub> = 10Ω
Gate-drain charge	Q <sub>gd</sub> *	_	0.3	_	nC	Vgs= -4.5V

<sup>\*</sup>Pulsed

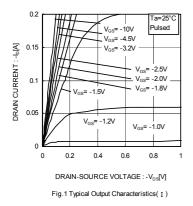
# ●Body diode characteristics (Source-drain)

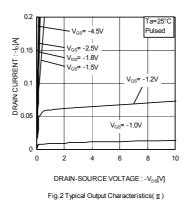
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp*	_	_	-1.2	V	I <sub>S</sub> = -200mA, V <sub>GS</sub> =0V

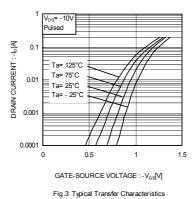
<sup>\*</sup>Pulsed

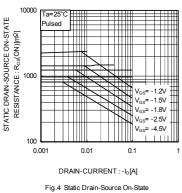
RZE002P02 Data Sheet

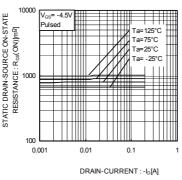
#### •Electrical characteristics curves











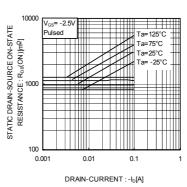
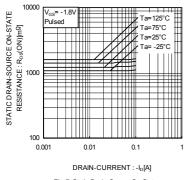
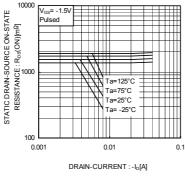


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current( I )



Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(Ⅲ)





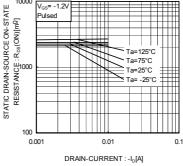
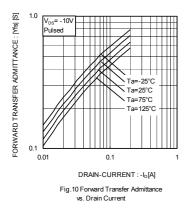
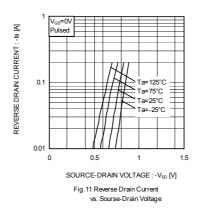


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(IV)

Fig.8 Static Drain-Source On-State Resistance vs. Drain Current( V )

Fig.9 Static Drain-Source On-State
Resistance vs. Drain Current(VI)





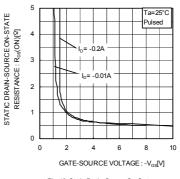
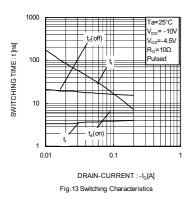
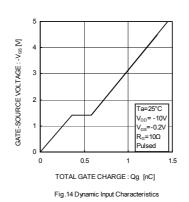
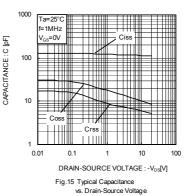


Fig.12 Static Drain-Source On-State Resistance vs. Gate Source Voltage







●Measurement circuit

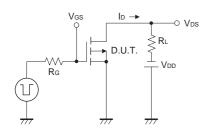


Fig.1-1 Switching Time Measurement Circuit

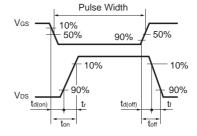


Fig.1-2 Switching Waveforms

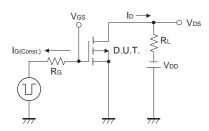


Fig.2-1 Gate Charge Measurement Circuit

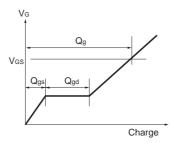


Fig.2-2 Gate Charge Waveform

### ●Notice

This product might cause chip aging and breakdown under the large electrified environment.

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